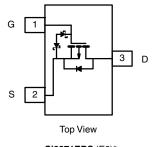


Vishay Siliconix

P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω) Max.	I _D (A) ^a	Q _g (Typ.)		
	0.045 at V _{GS} = - 10 V	- 4.8			
- 30	0.053 at V _{GS} = - 4.5 V	- 4.4	10.6 nC		
	0.080 at V _{GS} = - 2.5 V	- 3.6			

TO-236 (SOT-23)



Si2371EDS (E6)* * Marking Code

Si2371EDS-T1-GE3 (Lead (Pb)-free and Halogen-free)

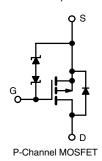
Ordering Information:

FEATURES

- TrenchFET[®] Power MOSFET ٠
- 100 % R_g Tested
- Built-in ESD Protection - Typical ESD Performance 3000 V
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Power Management for Portable and Consumer - Load Switches
 - OVP (Over Voltage Protection) Switch



ABSOLUTE MAXIMUM RATINGS	(T _A = 25 °C, unle	ess otherwise no	ted)		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 30	V		
Gate-Source Voltage		V _{GS}	± 12	7 V	
	T _C = 25 °C		- 4.8		
Continuous Drain Current (T, = 150 °C)	T _C = 70 °C	1-	- 3.8		
Continuous Dialit Current $(T_j = 150^{\circ} C)$	T _A = 25 °C	I _D	- 3.7 ^{b,c}		
	T _A = 70 °C		- 2.9 ^{b,c}	A	
Pulsed Drain Current (t = 300 µs)		I _{DM}	- 20		
Continuous Source-Drain Diode Current	T _C = 25 °C	la la	- 1.4		
	T _A = 25 °C	I _S	- 1 ^{b,c}		
	T _C = 25 °C		1.7		
Maximum Power Dissipation	T _C = 70 °C	PD	1.1	w	
Maximum Power Dissipation	T _A = 25 °C	١D	1 ^{b,c}	V	
	T _A = 70 °C		0.6 ^{b,c}		
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature) ^{d, e}			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R _{thJA}	100	130	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	60	75	0/11	

Notes:

a. $T_C = 25 \ ^{\circ}C.$

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 175 °C/W.

Document Number: 63924 For technical questions, contact: pmostechsupport@vishay.com S13-0633-Rev. A, 25-Mar-13 This document is subject to change without notice. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•			•		•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = -250 \mu A$	- 30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	II		- 24		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_{\rm D} = -230 \ \mu \Lambda$		2.2		- mv/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 0.6		- 1.5	V	
Gate-Source Leakage	1	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 10		
Gale-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$			± 1		
Zero Gate Voltage Drain Current	la a a	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μΑ	
Zero Gale Vollage Dialit Current	IDSS	V_{DS} = - 30 V, V_{GS} = 0 V, T_{J} = 55 °C			- 10	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 5 V, V_{GS} = - 10 V	- 15			Α	
Drain-Source On-State Resistance ^a		V _{GS} = - 10 V, I _D = - 3.7 A		0.037	0.045		
	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 2 A		0.044	0.053	Ω	
		V _{GS} = - 2.5 V, I _D = - 2 A		0.066	0.080		
Dynamic ^b				•			
Total Gate Charge	Qg	V_{DS} = - 15 V, V_{GS} = - 10 V, I_D = - 3.7 A		22.8	35	nC	
				10.6	16		
Gate-Source Charge	Q _{gs}	V_{DS} = - 15 V, V_{GS} = - 4.5 V, I_{D} = - 3.7 A		1.7			
Gate-Drain Charge	Q _{gd}			2.6			
Gate Resistance	R _g	f = 1 MHz	2.2	11	22	Ω	
Turn-On Delay Time	t _{d(on)}			28	42		
Rise Time	t _r t _{d(off)}	V_{DD} = - 15 V, R_L = 5.2 Ω		65	98		
Turn-Off Delay Time		$\rm I_D \cong$ - 2.9 A, $\rm V_{GEN}$ = - 4.5 V, $\rm R_g$ = 1 Ω		47	71		
Fall Time	t _f			62	93	ns	
Turn-On Delay Time	t _{d(on)}			7	14	115	
Rise Time	t _r	V_{DD} = - 15 V, R_L = 5.2 Ω		8	16	-	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 2.9 A, V_GEN = - 10 V, R_g = 1 Ω		52	78		
Fall Time	t _f			52	78		
Drain-Source Body Diode Characterist	ics			1	1	ī	
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 1.4	A	
Pulse Diode Forward Current	I _{SM}				- 20		
Body Diode Voltage	V _{SD}	$I_{\rm S}$ = - 2.9 A, $V_{\rm GS}$ = 0 V		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			13	20	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 2.9 A, dl/dt = 100 A/μs, T _J = 25 °C		6	12	nC	
Reverse Recovery Fall Time	t _a	$r_{\rm F} = 2.0$ Å, $u_{\rm F}u_{\rm c} = 100$ Å/ μ_0 , $r_{\rm J} = 20$ O		9		ns	
Reverse Recovery Rise Time	t _b			4			

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

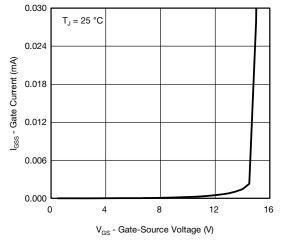
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

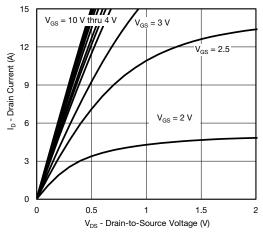


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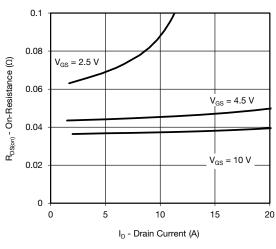
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



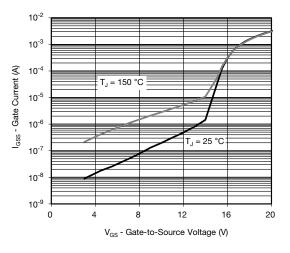
Gate Current vs. Gate-Source Voltage



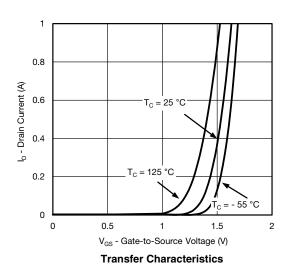


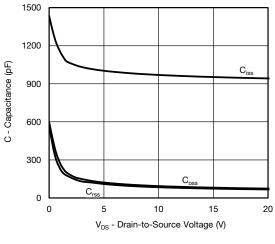


On-Resistance vs. Drain Current



Gate Current vs. Gate-Source Voltage





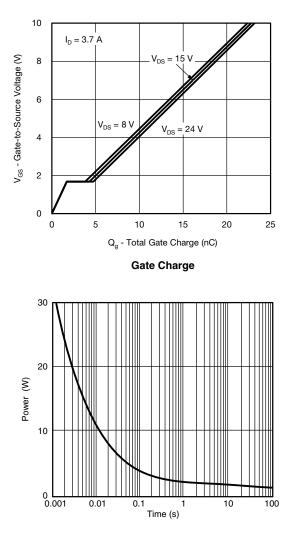


3

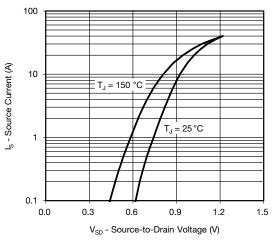


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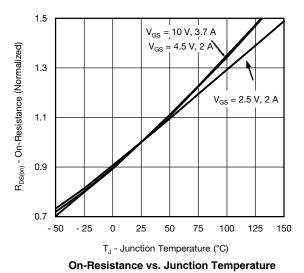
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

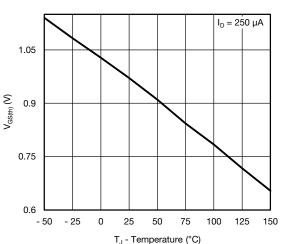


Single Pulse Power, Junction-to-Ambient

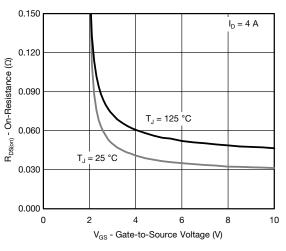


Soure-Drain Diode Forward Voltage







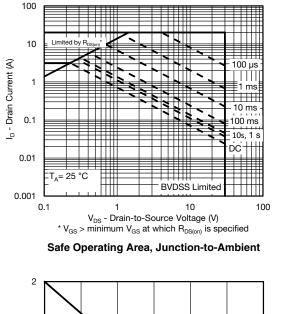


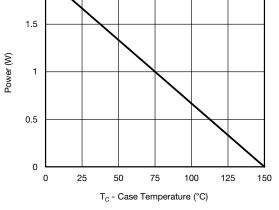
On-Resistance vs. Gate-to-Source Voltage



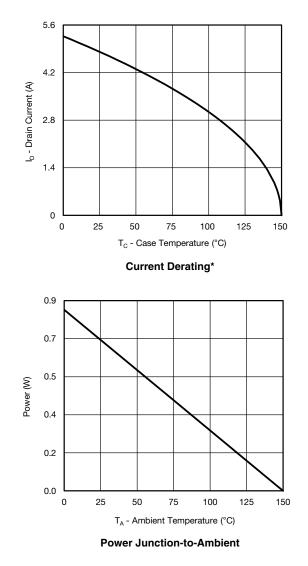
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Power Junction-to-Case

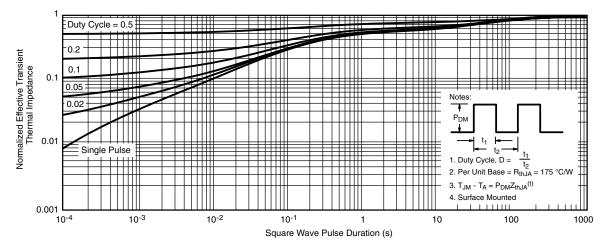


* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

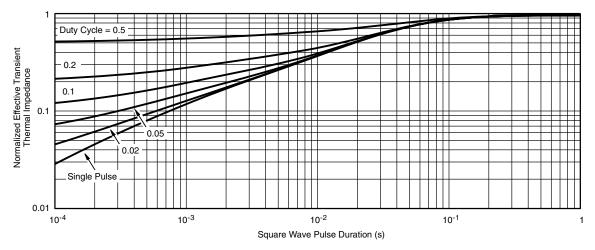


Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63924.



Package Information

Vishay Siliconix

SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	METERS	INCHES			
	Min	Max	Min	Мах		
Α	0.89	1.12	0.035	0.044		
A ₁	0.01	0.10	0.0004	0.004		
A ₂	0.88	1.02	0.0346	0.040		
b	0.35	0.50	0.014	0.020		
С	0.085	0.18	0.003	0.007		
D	2.80	3.04	0.110	0.120		
E	2.10	2.64	0.083	0.104		
E ₁	1.20	1.40	0.047	0.055		
е	0.95 BSC		0.0374 Ref			
e ₁	1.90 BSC		0.0748 Ref			
L	0.40	0.60	0.016	0.024		
L ₁	0.64 Ref		0.025	0.025 Ref		
S	0.50 Ref		0.020	0.020 Ref		
q	3°	8°	3°	8°		



Application Note 826

Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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